

Datasheet AS1363

500mA, Low-Dropout Linear Voltage Regulator

General Description

The AS1363 is a low-dropout linear regulator that operates from a +2.0V to +5.5V supply and delivers a guaranteed 500mA load current with low 150mV dropout.

The device is available in two versions (see Table 1). One version has a high-accuracy output with a preset voltage (1.2, 1.5, 1.8, 3.0, 3.3, or 4.5V). This voltage is internally trimmed and also offers a Bypass pin. With a capacitor connected to this Bypass pin, the PSRR and the Noise performance is improved.

At the other version the output voltage is user-adjustable (1.2V to 5.3V) and offers an SET pin for setting the output voltage.

Table 1. Standard Products

Model	Output Type	BYP	SET
AS1363-AD	Adjustable	No	Yes
AS1363	Fixed	Yes	No

A low supply current (65µA typ.) at maximum load is making the device ideal for portable battery-operated equipment.

Other features are included such as an active-low opendrain reset output that indicates when the output is out of regulation, a low-current (30nA typ.) shutdown mode, an integrated short-circuit and a thermal shutdown protection.

The AS1363 is available in a 6-pin SOT23 package.

2 Key Features

Guaranteed Output Current: 500mA

Low Dropout: 150mV @ 500mA

2.0V to 5.5V Input Voltage

Fixed Output Voltage: 1.2V to 5.0V

User-Adjustable Output Voltage: 1.2V to 5.3V

Power OK Output

Low Quiescent Current: 40µA

Low Shutdown Current: 30nA

Thermal Overload Protection

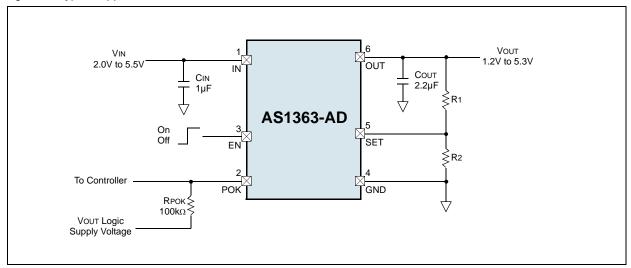
Output Current Limit

6-pin SOT23 Package

3 Applications

The device is ideal for laptops, PDAs, portable audio devices, mobile phones, cordless phones, and any other battery-operated portable device.



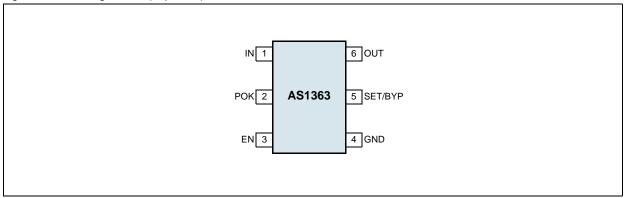




4 Pinout

Pin Assignments

Figure 2. Pin Assignments (Top View)



Pin Descriptions

Table 2. Pin Descriptions

Pin Number	Pin Name	Description			
1	IN	+2.0V to +5.5V Supply Voltage. Bypass this pin with a 1μF capacitor to GND (see			
-		Capacitor Selection and Regulator Stability on page 11).			
		Open-Drain POK Output. POK remains low while Vout is below the POK			
2	POK	threshold. Connect a $100k\Omega$ pull-up resistor from this pin to OUT to obtain an output			
		voltage (see Figure 1 on page 1).			
		Active-High Enable Input. A logic low reduces supply current below 30nA. In			
3	EN	shutdown mode, the POK output is low, and OUT is high impedance. Connect this			
		pin to IN for normal operation.			
4	GND	Ground			
		Voltage-Setting Input. Connect to GND for preset output or Connect to a resistive			
	SET	voltage-divider between OUT and GND to set the output voltage between 1.2V and			
5		5.3V (see Figure 1 on page 1).			
	BYP	Bypass Pin. Connect a 10nF capacitor from this pin to Vout to improve PSRR and			
	DIF	noise performance (see Figure 16 on page 9).			
		Output. Sources up to 500mA. Bypass this pin with a 2.2µF low-ESR capacitor to			
6	OUT	GND (see Figure 1 on page 1).			
		Note: For output voltages below 2V a 4.7µF capacitor should be used.			



5 Absolute Maximum Ratings

Stresses beyond those listed in Table 3 may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in Electrical Characteristics on page 4 is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Table 3. Absolute Maximum Ratings

Parameter	Min	Max	Units	Comments
IN, POK, EN, SET/BYP to GND	-0.3	+6	V	
OUT to GND	-0.3	VIN +0.3	V	
Output Short-Circuit Duration		1	min	
Continuous Power Dissipation		800	mW	TAMB = +70°C; derate 10mW/°C above +70°C
Operating Temperature Range	-40	+85	°C	
Storage Temperature Range	-65	+150	°C	
Junction Temperature		+150	°C	
Package Body Temperature		+260	°C	The reflow peak soldering temperature (body temperature) specified is in accordance with IPC/JEDEC J-STD-020D "Moisture/Reflow Sensitivity Classification for Non-Hermetic Solid State Surface Mount Devices". The lead finish for Pb-free leaded packages is matte tin (100% Sn).



6 Electrical Characteristics

VIN = VOUT(NOM) + 500mV or VIN = +2.0V (whichever is greater), $CIN = 1\mu F$, $COUT = 2.2\mu F$, EN = IN, TAMB = -40 to $+85^{\circ}C$ (unless otherwise specified). Typical values are at $TAMB = +25^{\circ}C$.

Table 4. Electrical Characteristics

Output Voltage Accuracy (Preset Mode)	1.96	V V V V mA
Output Voltage Accuracy (Preset Mode)	+0.75 +1.5 +2 5.3 1.23	% V V mA A
Output Voltage Accuracy (Preset Mode)	+1.5 +2 5.3 1.23 m	V V mA
VOUT Adjustable Output Voltage Range Range	+2 5.3 1.23 m	V V mA
Vout Adjustable Output Voltage Range 1.2	5.3 1.23 m	V mA
VOUT Adjustable Output Voltage Range 1.2 VSET/BYP SET/BYP Voltage Threshold (Adjustable Mode) VIN = 2.5V, IOUT = 100mA, VOUT set to 2.0V 1.17 1.20 IOUT Guaranteed Output Current (RMS) 500 500 500 600 ILIMIT Short-Circuit Current Limit VOUT = 0V 0.55 0.8 0.8 In-Regulation Current Limit VOUT > 96% of nominal value 0.8 50 100 ISET SET/BYP Input Bias Current VSET/BYP = 1.2V -100 -100 IQ Quiescent Current IOUT = 100μA 40 IOUT = 500mA 65	1.23 m	V mA
IOUT Guaranteed Output Current (RMS) Short-Circuit Current Limit Vout = 0V 0.55 0.8 ILIMIT Short-Circuit Current Limit Vout > 96% of nominal value 0.8 SET/BYP Threshold SET/BYP Input Bias Current VSET/BYP = 1.2V -100 -100 IQ Quiescent Current IOUT = 100µA 40 IOUT = 500mA 65	1.2 /	mA A
ILIMIT Short-Circuit Current Limit Vout = 0V 0.55 0.8 In-Regulation Current Limit Vout > 96% of nominal value 0.8 SET/BYP Threshold 50 100 ISET SET/BYP Input Bias Current VSET/BYP = 1.2V -100 -100 IQ Quiescent Current IOUT = 100μA 40 IOUT = 500mA 65	1.2	Α
In-Regulation Current Limit Vout > 96% of nominal value 0.8		
SET/BYP Threshold 50 100		
ISET SET/BYP Input Bias Current VSET/BYP = 1.2V -100 - IQ Quiescent Current IOUT = 100μ A 40 IOUT = $500m$ A 65	450	Α
IQ Quiescent Current IOUT = 100μA 40 IOUT = 500mA 65	150 m	mV
IQ Quiescent Current IOUT = 500mA 65	+100 n	nΑ
IOUT = 500mA 65	150	^
VIN - VOUT Dropout Voltage ² IOUT = 500mA VOUT = 2.5V 150	200 μ.	
	320 m	mV
Δ VLNR Line Regulation VIN from (Vout + 100mV) to 5.5V, ILOAD = 5mA + 0.125	-0.125 %	%/V
ΔVLDR Load Regulation IOUT = 1 to 500mA -0.001 +	-0.001 %/	%/m
f = 1kHz, Iout = 10mA, adjustable Output 65		
PSRR Ripple Rejection f = 10kHz, IouT = 10mA, adjustable Output 70	С	dB
f = 100kHz, IouT = 10mA, adjustable Output 60		
10Hz to 100kHz, IouT = 10mA, adjustable Output	\	μVRMS
Output Voltage Noise 100Hz to 100kHz, IouT = 10mA, adjustable Output 65	μν	
Shutdown	·	
IOFF Shutdown Supply Current EN = GND, VIN = 5.5V, TAMB = 25°C 0.03	0.5	μA
EN = GND, Vin = 5.5V	15	μΛ
ViH 2.0V < ViN < 5.5V		V
VIL 2.0V < VIN < 5.5V	0.6	V
IEN EN Input Bias Current EN = IN or GND, TAMB = +25°C 1		nΛ
TAMB = +85°C 5	'	nA



Table 4. Electrical Characteristics (Continued)

Symbol	Parameter	Condition		Тур	Max	Unit	
POK Output							
Vol	POK Output Low Voltage	POK sinking 1mA		0.05	0.25	V	
	Operating Voltage Range for Valid POK Signal	POK sinking 100μA	1.1		5.5	V	
	POK Output High leakage	$POK = 5.5V, TAMB = +25^{\circ}C$		1		nΛ	
	Current	$TAMB = +85^{\circ}C$		5		- nA	
	POK Threshold	Rising edge (referenced to Vout(NOM))	90	94	98	%	
Thermal Protection							
TSHDNN	Thermal Shutdown Temperature			170		°C	
\DeltaTSHDNN	Thermal Shutdown Hysteresis			20		٥C	

^{1.} Guaranteed by production test of load regulation and line regulation.

^{2.} Dropout voltage is defined as VIN - VOUT, when VOUT is 100mV below the value of VOUT measured for VIN = (VOUT(NOM) + 500mV). Since the minimum input voltage is 2.0V, this specification is only valid when VOUT(NOM) > 2.0V.



7 Typical Operating Characteristics

VIN = VOUT(NOM) + 0.5V, $CIN = 1\mu F$, $COUT = 2.2\mu F$, TAMB = 25°C (unless otherwise specified).

Figure 3. VDROP vs. IOUT;

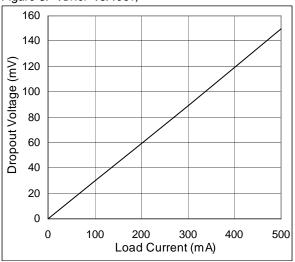


Figure 5. Vout vs. Temperature; Vout(NOM) = 2.5V

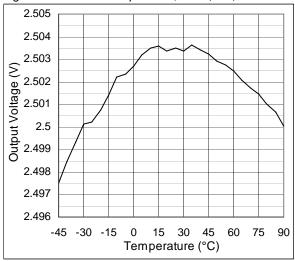


Figure 7. Quiescent Current vs. VIN; no load

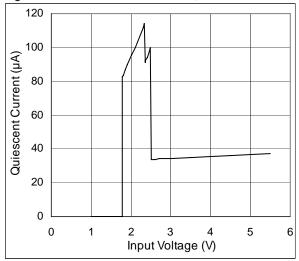


Figure 4. Vout vs. Iout; Vout(NOM) = 2.5V

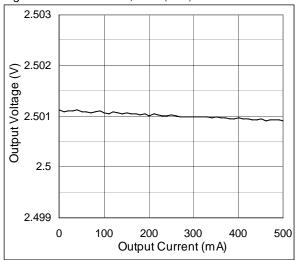


Figure 6. Vout vs. Vin; Vout(NOM) = 2.5V

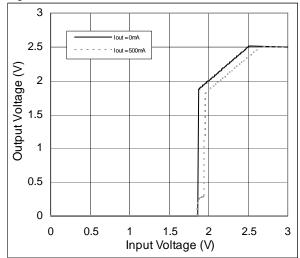


Figure 8. Quiescent Current vs. IOUT; VIN = 3.0V;

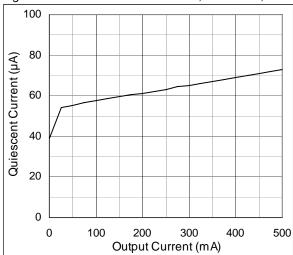
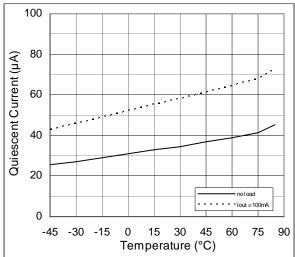




Figure 9. Quiescent Current vs. Temperature; VIN = 3.0V



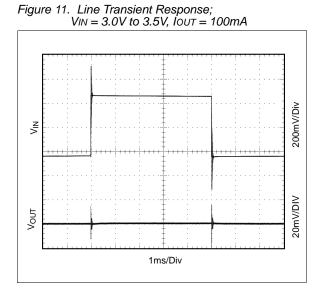


Figure 13. Startup; VIN = 3.0V, IOUT = 100mA

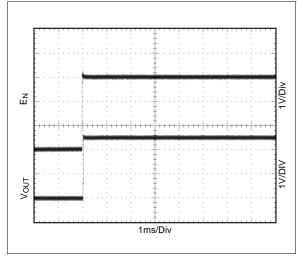


Figure 10. PSRR vs. Frequency; IouT = 10mA, CIN = 68nF,

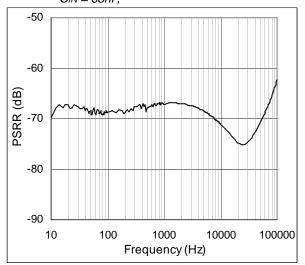


Figure 12. Load Transient Response; VIN = 3.0V, IOUT = 50mA to 250mA

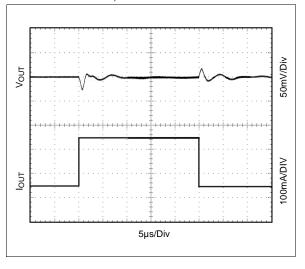
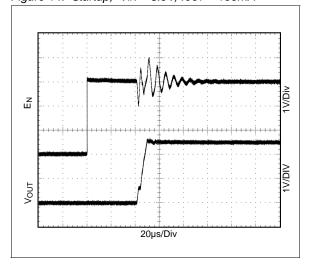


Figure 14. Startup; VIN = 3.0V, IOUT = 100mA



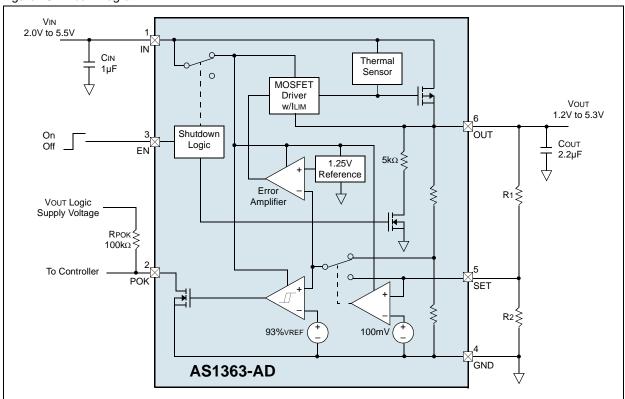


8 Detailed Description

The AS1363 is a low-dropout, low-quiescent-current linear regulator specifically designed for battery-powered devices. The regulator supplies loads of up to 500mA and can deliver a factory-preset output voltage or user-adjustable output voltage.

The device features a 1.2V reference, error amplifier, P-channel pass transistor, and internal feedback voltage-divider (see Figure 15). Additional blocks include an output current limiter, thermal sensor, and shutdown logic.

Figure 15. Block Diagram



The 1.2V reference is connected to the error amplifier, which compares this reference with the feedback voltage and amplifies the difference. If the feedback voltage is lower than the reference voltage, the pass-transistor gate is pulled lower, allowing more current to pass to the output and increases the output voltage. If the feedback voltage is too high, the pass transistor gate is pulled up, allowing less current to pass to the output.

The output voltage is delivered back through either an internal resistive divider connected to OUT or an external resistor network connected to SET (see Figure 15). The comparator examines VSET/BYP and selects the feedback path. If VSET/BYP is less than 50mV, the internal feedback path is used and the output is regulated to the factory-preset voltage (see Ordering Information on page 13).

Internal P-Channel Pass Transistor

The AS1363 features a P-channel MOSFET pass transistor and consumes only a maximum of 200μA of quiescent current under heavy loads as well as in dropout.

Shutdown

If pin EN is connected to GND the AS1363 is disabled. In shutdown mode all internal circuits are turned off, reducing supply current to 30nA (typ.). For normal operation pin EN must be connected to IN. During shutdown, POK is low.



Output Voltage Selection

The AS1363 is available in two versions (see Ordering Information on page 13). One version can only operate at one fixed output voltage and the other version can operate with a preset output voltage or with user-adjustable output voltages (1.2V to 5.3V).

- For the fixed output voltage version connect a capacitor CBYP from pin BYP to VOUT to improve PSRR and Noise performance (see Figure 16).
- To use the factory preset output voltage of the user-adjustable output voltage version, connect pin SET to GND (see Figure 17).
- For configurations using an output voltage other than the factory preset, a voltage-divider from OUT to SET to GND is required, as shown in (see Figure 1 on page 1). A value for R₂ in the 25kΩ to 100kΩ range should be sufficient. Calculate the value for R₁ as:

$$R_1 = R_2 \times \left(\frac{V_{OUT}}{V_{SETBYP}} - 1\right) \tag{EQ 1}$$

Where:

VOUT is in a range from 1.2V to 5.3V. VSET/BYP = 1.2V.

Figure 16. Fixed Output Voltage

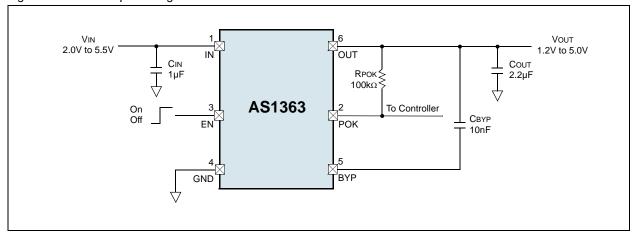
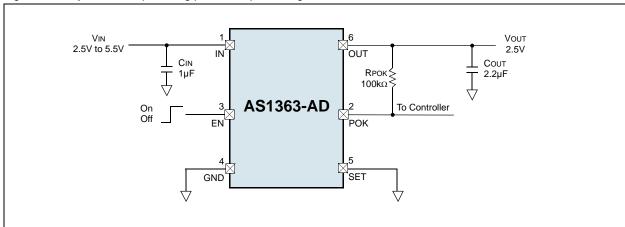


Figure 17. Adjustable Output using preset Output Voltage





Power-OK

The AS1363 features a power-ok indicator that asserts when the output voltage falls out of regulation. The open-drain POK output goes low when output voltage at OUT falls 6% below its nominal value. A $100k\Omega$ pull-up resistor from POK to a (typically OUT) provides a logic control signal.

POK can be used as a power-on-reset (POR) signal to a microcontroller or can drive an external LED to indicate a power failure condition.

Note: POK is low during shutdown.

Current Limit

The AS1363 features current limiting circuitry that monitors the pass transistor, limiting short-circuit output current to 0.8A (typ). The circuitry of the AS1363 allows that the output can be shorted to ground for an indefinite period of time without damaging the device.

Thermal Overload Protection

Integrated thermal overload protection limits the total power dissipation in the AS1363. When the junction temperature (TJ) exceeds +170°C typically, the pass transistor is turned off. Normal operation is continued when TJ drops approximately 20°C.

Note: Regardless of the hysteresis, continuous short-circuit condition will result in a pulsed output.

Operating Region and Power Dissipation

Maximum power dissipation depends on the thermal resistance of the IC package and circuit board, the temperature difference between the die junction and ambient air, and the rate of air flow.

The power dissipated in the device is given as:

$$PD = I_{OUT} \times (V_{IN} - V_{OUT})$$
 (EQ 2)

The AS1363 can deliver up to 0.5A RMS and operates with input voltages up to +5.5V, but not at the same time. High output currents can only be sustained when input/output differential voltages are low.

The maximum allowed power dissipation is 800mW at TAMB = +70°C or:

$$PDMAX = \frac{T_{J(max)} - T_{AMB}}{\theta_{JC} + \theta_{CA}}$$
 (EQ 3)

Where:

 $T_{J(MAX)}$ - TAMB is the temperature difference between the device die junction and the surrounding air. θ_{JC} is the thermal resistance of the junction to the case.

 θ CA is the thermal resistance from the case through the PCB, copper traces, and other materials to the surrounding air.

Note: For best heat transfer, the copper area should be equally shared between the IN, OUT, and GND pins.



9 Application Information

Capacitor Selection and Regulator Stability

Input and output capacitors are required for stable operation of the AS1363 over the full temperature range and with load currents up to 500mA. Connect CIN and COUT as close to the AS1363 as possible to minimize the impact of PC board trace inductance.

For CIN, connect a 1μF capacitor between IN and ground. CIN lowers the source impedance of the input supply. Reduce noise and improve load-transient response, stability, and power supply rejection by using larger output capacitors, such as 10μF.

For Cout connect a $2.2\mu\text{F}$ low-ESR capacitor between OUT and ground. The output capacitor's ESR affects stability and output noise. Use output capacitors with an ESR of 0.1Ω or less to ensure stability and optimum transient response. Surface-mount ceramic capacitors have very-low ESR and are commonly available in values up to $10\mu\text{F}$.

For output voltages less than 2V, use a 4.7µF low-ESR output capacitor for Cout.

Noise, Power Supply Rejection Ratio, and Transient Response

The AS1363 is designed to operate with low dropout voltages and low quiescent currents in battery-powered systems while still maintaining good noise response, transient response, and AC rejection. See Typical Operating Characteristics on page 6 for a plot of power-supply rejection ratio (PSRR) versus frequency. When operating from noisy sources, improved supply-noise rejection and transient response can be achieved by increasing the values of the input and output bypass capacitors and through passive filtering techniques.

Dropout Voltage

Because the AS1363 uses a P-channel MOSFET pass transistor, its dropout voltage is a function of drain-to-source on-resistance (RDS(ON)) multiplied by the load current:

$$V_{DROPOUT} = V_{IN} - V_{OUT} = R_{DS(ON)} \times I_{OUT}$$
 (EQ 4)

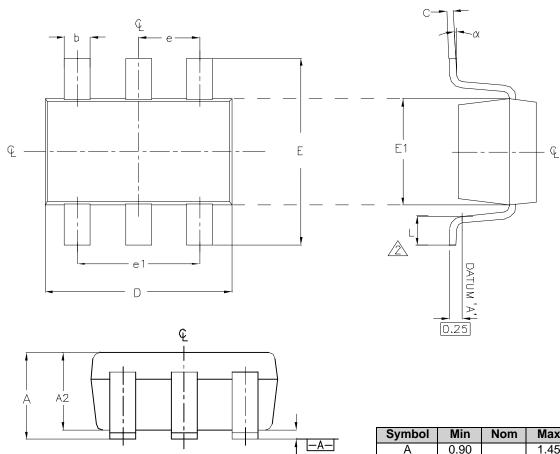
Note: The AS1363 ground current remains below 200µA in dropout.



10 Package Drawings and Markings

The device is available in an 6-pin SOT23 package.

Figure 18. 6-pin SOT23 Package



△ | -A- | .10

Notes:

- 1. Dimensions are in millimeters (mm).
- 2. Foot length measured at intercept point between datum A and lead surface.
- 3. Package outline exclusive of mold flash and metal burr.
- 4. Package outline inclusive of solder plating.
- 5. Complies with EIAJ SC74A.

Symbol	Min	Nom	Max	
Α	0.90		1.45	
A1	0.00		0.15	
A2	0.90		1.30	
b	0.30		0.50	
С	0.09		0.20	
D	2.80		3.05	
Е	2.60		3.00	
E1	1.50		1.75	
L	0.30		0.55	
Е	0.95Ref			
e1	1.90Ref			
α	00		8º	



11 Ordering Information

The device is available as the standard products shown in Table 5.

Table 5. Ordering Information

Model	Marking	Output	SET/BYP	Delivery Form	Package
AS1363-BSTT-AD	ASQ9	adjustable (preset to 2.5V)	SET	Tape and Reel	6-pin SOT23
AS1363-BSTT-12*	ASRY	1.2V	BYP	Tape and Reel	6-pin SOT23
AS1363-BSTT-15*	ASRA	1.5V	BYP	Tape and Reel	6-pin SOT23
AS1363-BSTT-18*	ASRB	1.8V	BYP	Tape and Reel	6-pin SOT23
AS1363-BSTT-30*	ASRC	3.0V	BYP	Tape and Reel	6-pin SOT23
AS1363-BSTT-33*	ASRD	3.3V	BYP	Tape and Reel	6-pin SOT23
AS1363-BSTT-45*	ASRE	4.5V	BYP	Tape and Reel	6-pin SOT23

All devices are RoHS compliant and free of halogene substances.

Non-standard devices are available between 1.4V and 4.6V in 50mV steps and between 4.6V and 5.0V in 100mV steps. For more information and inquiries contact http://www.austriamicrosystems.com/contact-us

^{*}Future product.



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Contact Information

Headquarters

austriamicrosystems AG A-8141 Schloss Premstaetten, Austria

Tel: +43 (0) 3136 500 0 Fax: +43 (0) 3136 525 01

For Sales Offices, Distributors and Representatives, please visit:

http://www.austriamicrosystems.com/contact-us